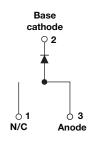
Vishay Semiconductors

HEXFRED[®] Ultrafast Soft Recovery Diode, 25 A



www.vishay.com

TO-263AB (D²PAK)



PRODUCT SUMMARY								
Package	TO-263AB (D ² PAK)							
I _{F(AV)}	25 A							
V _R	600 V							
V _F at I _F	1.3 V							
t _{rr} (typ.)	23 ns							
T _J max.	150 °C							
Diode variation	Single die							

FEATURES

- Ultrafast and ultrasoft recovery
- Very low I_{RRM} and Q_{rr}
- Specified at operating conditions
- Meets MSL level 1, per J-STD-020, LF maximum RoHS peak of 260 °C COMPLIANT HALOGEN
- AEC-Q101 gualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION

VS-HFA25TB60S is a state of the art ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 25 A continuous current, the VS-HFA25TB60S is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{BBM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA25TB60S is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Cathode to anode voltage	V _R		600	V					
Maximum continuous forward current	I _F	T _C = 100 °C	25						
Single pulse forward current	I _{FSM}		225	А					
Maximum repetitive forward current	I _{FRM}		100						
Maximum newer discinction	р	T _C = 25 °C	125	W					
Maximum power dissipation	P_D	T _C = 100 °C	50	vv					
Operating junction and storage temperature range	T _J , T _{Stg}		-55 to +150	°C					

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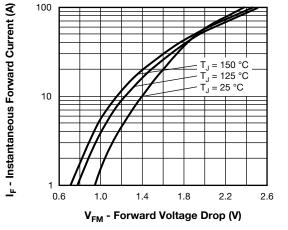
ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA		600	-	-			
		I _F = 25 A		-	1.3	1.7	V		
Maximum forward voltage	V _{FM}	I _F = 50 A	See fig. 1	-	1.5	2.0			
		I _F = 25 A, T _J = 125 °C		-	1.3	1.7			
Maximum reverse		$V_R = V_R$ rated	See fig. 2	-	1.5	20			
leakage current	I _{RM}	$T_J = 125 \text{ °C}, V_R = 0.8 \text{ x } V_R \text{ rated}$	See lig. 2	-	600	2000	μA		
Junction capacitance	CT	V _R = 200 V	See fig. 3	-	55	100	pF		
Series inductance	L _S	Measured lead to lead 5 mm from pa	ackage body	-	8.0	-	nH		

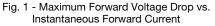
DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS				
Reverse recovery time See fig. 5	t _{rr}	I _F = 1.0 A, dI _F /dt = 200	A/ μ s, V _R = 30 V	-	23	-				
	t _{rr1}	T _J = 25 °C		-	50	75	ns			
	t _{rr2}	T _J = 125 °C	I _F = 25 A dI _F /dt = 200 A/µs V _R = 200 V	-	105	160				
Peak recovery current	I _{RRM1}	T _J = 25 °C		-	4.5	10	A			
See fig. 6	I _{RRM2}	T _J = 125 °C		-	8.0	15				
Reverse recovery charge	Q _{rr1}	T _J = 25 °C		-	112	375				
See fig. 7	Q _{rr2}	T _J = 125 °C		-	420	1200				
Peak rate of fall recovery current during t _h	dl _{(rec)M} /dt1	T _J = 25 °C		-	250	-	A∕µs			
See fig. 8	dl _{(rec)M} /dt2	T _J = 125 °C		-	160	-	λγμs			

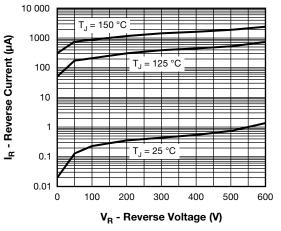
THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C			
Thermal resistance, junction to case	R _{thJC}		-	-	1.0	K/W			
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	80	r,∕ vv			
Woight			-	2.0	-	g			
Weight			-	0.07	-	oz.			
Marking device		Case style TO-263AB (D ² PAK)		HFA25	TB60S				



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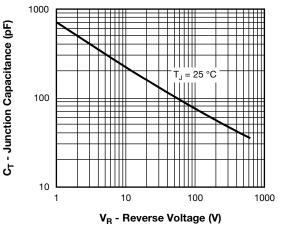


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

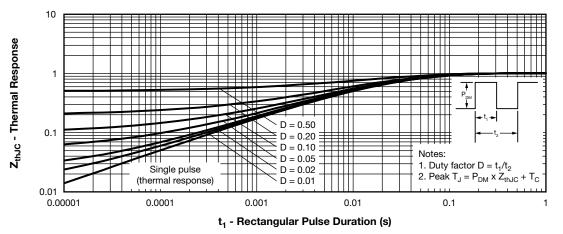


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics



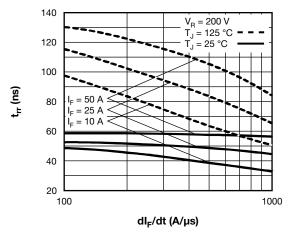


Fig. 5 - Typical Reverse Recovery Time vs. dI_F/dt

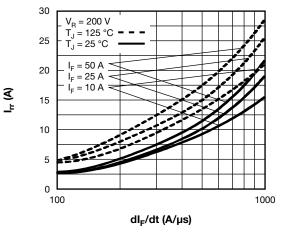
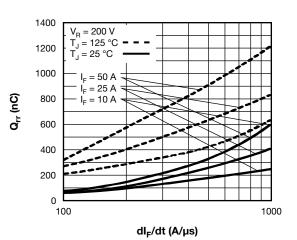
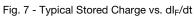


Fig. 6 - Typical Recovery Current vs. dl_F/dt

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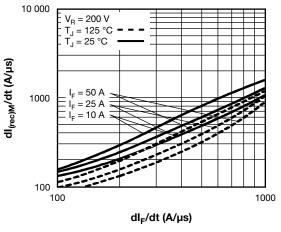


Fig. 8 - Typical dI_{(rec)M}/dt vs. dI_F/dt

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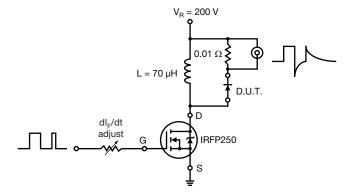
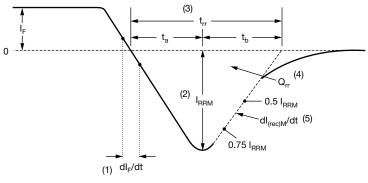


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dI_F/dt rate of change of current through zero crossing
- (4) ${\rm Q}_{\rm rr}$ area under curve defined by ${\rm t}_{\rm rr}$ and ${\rm I}_{\rm RRM}$
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.
- (5) dl_{(rec)M}/dt peak rate of change of current during t_b portion of t_{rr}

 $Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$

Fig. 10 - Reverse Recovery Waveform and Definitions

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ORDERING INFORMATION TABLE

Device code	vs-	HF	Α	25	тв	60	S	TRL	PbF		
		2	3	4	5	6	7	8	9		
	- 3 · 4 · 5 ·	 Vishay Semiconductors product HEXFRED[®] family Process designator: A = electron irradiated Current rating (25 = 25 A) Package outline (TB = TO-220, 2 leads) Voltage rating (60 = 600 V) 									
	8 -	• N	• None = tube								
		 TRL = tape and reel (left oriented) 									
		• TF	RR = tap	be and r	eel (righ	t orient	ed)				
	9 ·	• Pł	oF = lea	d (Pb)-fi	ee, for t	tube pa	ckaged				
		• P	= lead (Pb)-free	, for tap	e and r	eel pac	kaged			

ORDERING INFORMATION (Example)									
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION						
VS-HFA25TB60SPBF	50	1000	Antistatic plastic tube						
VS-HFA25TB60STRRP	800	800	13" diameter reel						
VS-HFA25TB60STRLP	800	800	13" diameter reel						

LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?95046						
Part marking information	www.vishay.com/doc?95054						
Packaging information	www.vishay.com/doc?95032						

Outline Dimensions



D²PAK

DIMENSIONS in millimeters and inches

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SHA



SYMBOL	MILLIMETERS		INC	HES	NOTES	SYMBOL	MILLIM	IETERS	INC	HES	NOTES	
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	STWDUL	MIN.	MAX.	MIN.	MAX.	NOTES	
A	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			E	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5 M-1994

⁽²⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

⁽³⁾ Thermal pad contour optional within dimension E, L1, D1 and E1

⁽⁴⁾ Dimension b1 and c1 apply to base metal only

⁽⁵⁾ Datum A and B to be determined at datum plane H

⁽⁶⁾ Controlling dimension: inch

⁽⁷⁾ Outline conforms to JEDEC[®] outline TO-263AB

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